Resin Plate Characteristics I

Epoxy Glass, Bakelite & Ceramics

O For Heat Insulation Plates, see P.3780-3791.

Characteristics of Epoxy Glass, Bakelite and Ceramics

Characteristics of Epoxy Glass Plate

Compared with paper based bakelite plates and fabric based bakelite plates, MISUMI's epoxy glass

plates have high strength (mechanical strength), excellent heat resistance and moisture resistance.

High Temperature Type has an excellent antistatic property.

Characteristics of Bakelite Plate

Transparent Resin / Glass / Mirror / Engineered Plastic Plates

MISUMI's Bakelite Plates are products which can be used as insulating plates for switch board, controller and breaker.

Paper Type is available in natural color and black. Strong Fabric Type is also available.

Bakelite Color (Natural Color) may vary depending on production lot, but does not affect quality.

Characteristics of Ceramics

Alumina 96: Ceramics (Alumina 96/99) are excellent in abrasion resistance/insulation/heat resistance, and used for insulating/heat resisting parts in electronics, semiconductors and in other areas. In addition, it has equal or higher bending strength, compared with the common steel, and little elastic deformation.

Steatite: Ceramics Steatite are excellent in insulation as well as high frequency characteristic and are used as general insulation parts. It is a relatively low-cost material.

Machinable: Excellent machinability. Can be machined into complex forms. Precision finishing. Provides an excellent electric and thermal insulation.

Physical Property Values of Fnoxy Glass and Rakelite

Physical Property Values of Epoxy Glass and Bakelite *For material colors or features, see P.3069												
				Part Number								
				Epoxy Gla	ass Plates	Bakelite						
				Standard	High Temperature	Paper Type	Fabric Type P.3887 P.3114					
		Item	Plates	P.3096	P.3096	P.3098-3099						
		ILGIII	Circular Plates	P.3114	_	P.3114						
			Unit	ЕРХА	EPXAR	BLA BLBA	BLSA					
Comp	Main Base M	aterial	_	Glass Fiber	Glass Fiber	Kraft Paper	Cotton					
Component	Main Materia	I	_	Epoxy Resin	Super-Insulated Epoxy	Phenol Resin	Phenol Resin					
<	Bending Strength		MPa {kgf/mm²}	310–450 {31–45}	499 (Vertical) / 553 (Horizontal) {51 (Horizontal) / 56 (Vertical)}	120–180 {12–18}	100–150 {10–15}					
ropi	Compression Strength Vertical to Lamination Horizontal to Lamination		MPa {kgf/mm²}	470-539 {47-53.9}	_	250-320 {25-32}	200-250 {20-25}					
Mechanical Properties			MPa {kgf/mm²}	294-392 {29.4-39.2}	_	170-210 {17-21}	100-150 {10-15}					
	Izot Impact S	trength	J/cm	4.6 or More	_	0.2-0.5	0.5-0.7					
	Cleavage Str	ength	kN	6.9-10.8	_	3.9-5.9	6.0-8.0					
Thermal Characteristics	Recommend Temperature	ed Operating (Note 1)	°C	Ambient Temperature: 155	Ambient Temperature: 260 (300°C Normal for 5 min.)	-50-100 (130°C 2 h Normal)	-50-100 (140°C 2 h Normal)					
nem	Reference -	Destructive Temp. (Note 2)	°C	_	_	120	140					
nal	Expansion Co	efficient	°C-1	6.05 x 10 ⁻⁵	6.0 x 10 ⁻⁵	1.6x10 ⁻⁴	0.6 x 10 ⁻⁴					
8	Thermal Con	ductivity	W/m.k {cal/cm.sec.°C}	0.471 {1.125 x 10 ⁻³ }	0.38 {9.0 x 10 ⁻⁴ }	0.21 {0.5 x 10 ⁻³ }	0.38 {0.9 x 10 ⁻³ }					
ᇤ	Dielectric Breakdown (Cross Layer)		kV/mm	20-30	_	20–28	12–20					
ectri.	Edgewise Withstand Voltage		kV	_	_	12–18	8–15					
C C	Volume	4 h / 150°C	Ω·cm	_	_	3.0 x 10 ⁹	4.0 x 10 ⁸					
nara	Resistivity	100 h / 25°C / 90% RH	Ω·cm	_	_	9.0 x 10 ⁸	5.0 x 10 ⁷					
cter	Surface Resistance			1013 - 10 ¹⁴	1.0 x 10 ⁷	5.0 x 10 ¹⁰	9.0 x 10 ⁸					
Electric Characteristics	Insulation Resistance Ordinary Condition After Boiling			1012 - 10 ¹⁴	_	1010 - 5 x 10 ¹¹	5 x 109 - 10 ¹⁰					
- čó				5 x 1010 - 10 ¹³	_	5 x 107 - 10 ⁸	108 - 10 ⁹					
9	Arc Resistance		sec	_	_	_	_					
Others	Water Absorption Ratio		%	0.02-0.03	0.02	0.5–1.3	1.6–1.8					
0,	Specific Grav	ity	_	1.75–1.9	1.95	1.4	1.4					

Testing method conforms to JIS K6911. O Listed values are not guaranteed values but representative values.

(Note 1) "Recommended Operating Temperature" is the temperature when a long-term use does not reduce the quality rapidly.

(Note 2) "Destructive Temperature" is the temperature to start carbonization, collapse and melt.

Physical Property Values of Ceramics

, , , , , , , , , , , , , , , , , , , ,											
		Part Number									
Item	Unit	CCES / PCCES	CEM								
Material Name	_	Alumina 96 Al ₂ O ₃ 96%	Alumina 99 Al ₂ O ₃ 99.5%	Steatite Mg0 / SiO ₂	Machinable SiO ₂ / MgO						
Apparent Density	g/cm ³	3.7	3.9	2.6	2.5						
Water Absorption Ratio	%	0	0	0	0						
Bending Strength	Mpa	350	450	160	94						
Thermal Conductivity	W/m·k	24	24	3	1.46						
Thermal Expansion	(20-500°C) x 10 ⁻⁶ /°C	7.2	8	7.8	9.4						
Coefficient	(20-800°C) x 10 ⁻⁶ /°C	7.9	_	8.2	12.6						
Melting Point	°C	2050	_	1557	1200						
Safety Operating Temperature	°C	1300	1300	1000	1000						
Insulation Resistance	kV/mm	>10	>10	>10	40						
Specific Volume Resistivity	Ω·cm	>1014	>1014	>1014	>1016						
Dielectric Constant	MHz	9	9	5.2	6.0						
Loss Coefficient	_	10.0 x 104	_	7 0 x 10 ⁴	_						

O Alumina 99 (Al₂O₃ 99.5%) is for CEA with plate thickness 2/2.5 or for plate thickness 1 with hole machining. O Listed values are not guaranteed values but representative values.

Drilling Conditions of the Epoxy Glass

3										
	Circular Cut	Milling	Drilling							
Tools	Carbide	Carbide	Carbide							
10015	(K-10)	(K-10)	Carbide (K-10) Carbide (K-10) ge - Small Blades 100-300 Large - Small Blades 120-350							
Cutting Speed V (m/min)	Large – Small Blades	Large - Small Blades	Large - Small Blades							
Cutting Speed v (III/IIIIII)	45-200	100-300	120-350							
Davalutions (r.n.m.)	Large - Small Blades	Large - Small Blades	Ø2 Drill 1000-1500							
Revolutions (r.p.m.)	50-1000	300-1000	Carbide (K-10) Large – Small Blades 120–350 Ø2 Drill 1000–1500							
Cutting Depth (mm)	0.3-0.5	0.5–2.0 —								
Feed (mm/Rotation)	0.1-0.2	0.1-0.2	0.1-0.5							

The above values are references only

Machinable Ceramics Drilling Conditions

	Tools	High-Speed Steel	Carbide			
	Cutting Speed (m/min)	9–15	30–50			
Circular Cut	Feed (mm/Rotation)	0.05-0.13				
	Cutting Depth (mm)	0.5–6				
	Cutting Speed (m/min)	_	6–11			
Milling	Feed (mm/Rotation)	_	0.05			
	Cutting Depth (mm)	_	0.5–5			
Note	Revolution Frequency	Revolutions per minute = Cutting Speed (m/min) / Diameter (mm) x 0.00314				

The above values are references only.

Resin Plates Characteristics II

General-Purpose Engineered Plastic Plates

Characteristics of MC Nylon, Polyacetal, Ultra High-molecular-weight Polyethylene (UHMW), Fluororesin, PEEK, PPS, ABS, PBT and Free-cutting Resin

MISUMI's general-purpose Engineered Plastic plates have superior properties of lightweight, noise reduction and corrosion resistance. They can be used as a replacement for metal plates. Selectable from nine types of materials and several grades for various purposes.

MC Nylon: Having better abrasion resistance than that of polyacetal plates, MC nylon is generally used for slide guide plates. The product lineup is as follows: Sliding Grade with highlyimproved sliding performance; High Strength Grade with excellent strength; three types of Conductive Grade effective for antistatic purposes; and Weather Resistance Grade superior in

Polyacetal: Widely used in wheels, rollers and gears, because of its excellent mechanical strength. MISUMI's polyacetal plates are offered in two colors: white and black. In addition, Sliding Grade with highly-improved sliding performance and Conductive Grade effective for antistatic purposes are also available.

Ultra High-Molecular-Weight Polyethylene (UHMW): It excels in abrasion resistance and sliding properties, and is used for carrier rollers and guide rails. In addition to Standard Grade, Conductive Grade effective for antistatic purposes is also available.

			*For material colors or features, see P.3069												
					Part Number Ultra High-molecular-										
ltem				MC Nylon						Polyacetal			lyethylene		
				Standard	Sliding	High Strength	Weather Resistance	Conductivity CDR2	Conductivity CDR6	Conductivity CDR9	Standard	Electric Conductivity	Standard	Electric Conductivity	
		Testing Method	Plates	P.3100, 3118	P.3100	P.3100	P.3100	P.3100	P.3100, 3118	P.3100	P.3102	P.3102	P.3104	P.3114	
			ASTM	Circular Plates	P.3114	P.3114	_	P.3114	P.3114	P.3114	P.3114	P.3114	P.3114	P.3114	P.3114
			Unit	MCA MCAW MCAB	MCAS	MCAY	MCAPS	MCCA	MCDA MCDB	MCEA	PAA PABA PAAB	PACA	UPA	UPACA	
		Normal Temperature		MPa	96	66	98	83	68	74	88	61	42	45	35
	Tensile Strength	<u> </u>	D-638	{kgf/cm²}	{980}	{670}	{1000}	{850}	{700}	{760}	{900}	{620}	{430}	{460}	{360}
	Tensile suengui	Continuous Use at High Temperature	D-030	MPa {kgf/cm ² }	39 (120°C) {400 (120°C)}	_	_	_	_	_	_	29 (95°C) {300 (95°C)}	_	_	_
≥	Elongation		D-638	%	30	19	20	40	10	7	7	40	30	400	300
echa	Bending Strength		D-790	MPa	110	92	152	110	117	117	132	89	49	25	25
ınica				{kgf/cm²}	{1120}	{940}	{1550}	{1120}	{1200}	{1200}	{1350}	{910}	{500}	{250}	{250}
l Pro	Flexural Modulus		D-790	MPa MPa	3530	2599	4609	101	4110	4020	4160	2589	1370	900	1103
Mechanical Properties	Compression	Yield Point	D-695	{kgf/cm ² }	103 {1050}	_		{1030}	_	_	_	_	_	{200}	_
0,	Strength	5% Deformation		MPa {kgf/cm ² }	95 {970}	75 {760}	118 {1200}	93 {948}	98 {1000}	93 {950}	_	103 {1050}	44 {450}	_	25 {250}
	Izot Impact Streng		D-256	J/m	50	39	50	50	35	35	35	74	77	Does Not Break	Does Not Break
	Rockwell	R Scale		_	120	110	120	120	119	117	119	119	111	56	52
	Hardness	M Scale	D-785	_	_	_	_		_	_	_	78	_	_	_
Thermal Characteristics	Temperature of Continuous Use		_	°C	-40–120	-40–120	Ambient Temp.: 150	Ambient Temp.: 120	Ambient Temp.: 120	Ambient Temp.: 120	Ambient Temp.: 150	-45–95	Ambient Temp.: 80	-100–80	-100–80
nal (Melting Point			°C	222	221	222	222	215	215	218	165	_	136	_
hara	Deflection Temp. Under Load	0.45 Mpa	D-648	°C	215	215	215	215	215	215		158	_	80	108
cteri		1.82Mpa	D-696	°C °C ⁻¹	200 9.0 x 10 ⁻⁵	115 9.0 x 10 ⁻⁵	200 6.5 x 10 ⁻⁵	200 9.0 x 10 ⁻⁵	200 8.0 x 10 ⁻⁵	200 7.5 x 10 ⁻⁵	200 8.6 x 10 ⁻⁵	110 9.0 x 10 ⁻⁵	106 16.7 x 10 ⁻⁵	1.7 x 10 ⁻⁴	55 19 x 10⁻⁵
stics	Linear Expansion Coefficient Thermal Conductivity		D-030	W/m·k	0.233	0.233	- 0.5 X 10	0.23	0.512	0.709	- 0.0 X 10	0.233	10.7 × 10	0.42	—
	Surface Resistivity		D-257	_	_	_		—	—	_	_	—	_	10 ¹³	_
hara	Specific Volume R		D-257	Ω·cm	4.2 x 10 ¹⁵	_	_	_	10 ² -10 ⁴	10 ⁴ -10 ⁶	10 ⁶ -10 ⁸	>1014	10 ¹⁰ -10 ¹²	10 ¹⁷	10 ⁴
ectri	Insulation Breakdo		D-149	kV/mm	20	_	_	18	_	_	_	20	_	68	_
Electric Characteristics	Dielectric Constant	10 ⁶ Hz	D-150		3.7	_		3.7				3.7	_	2.3	
-	Dissipation Factor	10 ⁶ Hz	D-150		0.02 1.16	1.11	1.27	0.02 1.16	1.2	1.23	1.19	0.007 1.41	1.33	0.94	0.95
	Specific Gravity	In Water, Level	D-792 D-570	%	6	-	1.2 <i>I</i>	6.0	- I.Z	1.23	- 1.19	0.7	- 1.33	<0.01	
	Water Absorption Ratio	In Water, 24hs	D-570	%	0.8	0.5	_	0.8	_	_	_	0.22	2	0.8	_
	Abrasion Resistance		_	_	Good	Excellent	Good	Excellent	Acceptable	Acceptable	Good	Acceptable	Good	Excellent	Good
	Sliding Properties		_	_	Good	Excellent	Good	Good	Good	Good	Good	Good	Good	Excellent	Good
	Dynamic Friction (0.05-0.1					_		0.18	0.07-0.22	0.17-0.19
	Dimension Stabilit	,	_		Acceptable	Acceptable	Acceptable	Acceptable	Acceptable	Acceptable	Acceptable	Good	Acceptable	Acceptable	Acceptable
0thers	Impact Resistance	!			Good	Good	Good		Good	Good	Good	Good	Good	Excellent	Excellent
ers	Flame Resistance		[UL94]	_	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)
	Food Sanitation Laws		_	_	Suitable*	Suitable*	Suitable*	Suitable (After Boiling)	Suitable*	Suitable*	Suitable*	Suitable	Suitable	Suitable	Suitable
	FDA Registration		_		— 0- 1	— O- 1	— —		-	-	— —	— —	— 0d	Finished	
		Oil			Good	Good	Good	Good	Good	Good	Good	Good Acceptable	Good Acceptable	Good	Good
	Chemical	Acid	_	_	Poor Good /	Poor Good /	Poor Good /	Poor Good /	Poor Good /	Poor Good /	Poor Good /	/ Poor	/ Poor	Excellent	Good
	Resistance	Alkali Organic	_		Acceptable	Acceptable	Acceptable	Acceptable	Acceptable	Acceptable	Acceptable	Good	Good	Excellent	Good
+0		Solvent	_	_	Good	Good	Good	Good	Good	Good	Good	Good	Good	Excellent	Good

*Comply with Food Sanitation Laws in Japan (MC Nylon, Standard, Sliding Grade and High Strength Grade: After boiling for 1.5 hours; Conductive CDR2, CDR6 and CDR9: After boiling for 2 hours)

Listed values are not guaranteed values but representative values.

